

# PRM011N10S8

# PFC Device Corporation

# 100V Single N-Channel MOSFET

# Major ratings and characteristics

Characteristics	Values	Units
V <sub>DS</sub>	100	٧
I <sub>D</sub> (T <sub>A</sub> =25°C)	50	Α
Max. R <sub>DS(ON)</sub> @V <sub>GS</sub> =10V	11	mΩ
Max. R <sub>DS(ON)</sub> @V <sub>GS</sub> =4.5V	15	mΩ
T <sub>J</sub> Operating Junction Temperature	-55 to +150	°C

# **General Description**

The N-Channel enhancement mode power field effect transistor is using trench DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. The device is well suited for high efficiency fast switching applications.

# PRM011N10S8 SOP-8

# **Typical Applications**

- Charger Adapter
- Power Tools
- LED Lighting

### **Features**

- Max. R<sub>DS(ON)</sub>=11mΩ@V<sub>GS</sub>=10V
- Improved dv/dt capability
- Fast switching
- 100% E<sub>AS</sub> Guaranteed
- Green Device Available

# 1. Characteristics

# **Maximum Ratings Characteristics**

( $T_A = 25$  °C unless otherwise specified)

Symbol	Parameter	Rating	Units
$V_{DS}$	Drain-Source Voltage	100	V
$V_{GS}$	Gate-Source Voltage	±20	V
I <sub>D</sub> <sup>5</sup>	Drain Current – Continuous (T <sub>A</sub> =25°C)	50	Α
ID	Drain Current – Continuous (T <sub>A</sub> =100°C)	32	Α
I <sub>DM</sub>	Drain Current – Pulsed <sup>1</sup>	201	Α
E <sub>AS</sub>	Single Pulse Avalanche Energy <sup>2</sup>	26	mJ
I <sub>AS</sub>	Single Pulse Avalanche Current <sup>2</sup>	23	А
ь	Power Dissipation (T <sub>A</sub> =25°C)		W
P <sub>D</sub>	Power Dissipation – Derate above 25°C	0.38	W/°C
T <sub>STG</sub>	Storage Temperature Range	-55 to 150	°C
T <sub>J</sub>	Operating Junction Temperature Range	-55 to 150	°C

### **Thermal Characteristics**

Symbol	Parameter	Тур.	Max.	Unit
$R_{ heta JA}$	Thermal Resistance Junction to Ambient		52	°C/W
$R_{ heta JC}$	Thermal Resistance Junction to Case		2.6	°C/W



Version 4.0 2 / 7

### **Electrical Characteristics**

( $T_J = 25$  °C unless otherwise specified)

### Off Characteristics

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
$BV_{DSS}$	Drain-Source Breakdown Voltage	$V_{GS}$ =0V, $I_D$ =250uA	100			V
	Drain Source Leekage Current	V <sub>DS</sub> =100V, V <sub>GS</sub> =0V, T <sub>J</sub> =25°C			1	uA
I <sub>DSS</sub>	Drain-Source Leakage Current	V <sub>DS</sub> =80V, V <sub>GS</sub> =0V, T <sub>J</sub> =100°C			100	uA
I <sub>GSS</sub>	Gate-Source Leakage Current	V <sub>GS</sub> =±20V, V <sub>DS</sub> =0V			±100	nA

### On Characteristics

D	Static Drain-Source On-Resistance	V <sub>GS</sub> =10V, I <sub>D</sub> =20A			11	mΩ
$R_{DS(ON)}$		V <sub>GS</sub> =4.5V, I <sub>D</sub> =10A			15	mΩ
$V_{GS(th)}$	Gate Threshold Voltage	$V_{GS}=V_{DS}$ , $I_{D}=250uA$	1.0		2.5	V
<b>g</b> fs	Forward Transconductance	V <sub>DS</sub> =5V, I <sub>D</sub> =10A	-	49		S

**Dynamic and switching Characteristics** 

	Dynamic and Switching Characteristics					
$Q_{g}$	Total Gate Charge <sup>3, 4</sup>			25		
$Q_gs$	Gate-Source Charge <sup>3, 4</sup>	$V_{DS}$ =50V, $V_{GS}$ =10V, $I_{D}$ =20A		4		nC
$Q_{gd}$	Gate-Drain Charge <sup>3, 4</sup>			6		
$T_{d(on)}$	Turn-On Delay Time <sup>3, 4</sup>			8		
T <sub>r</sub>	Turn-On Rise Time <sup>3, 4</sup>	$V_{DD}$ =50V, $V_{GS}$ =10V, $R_{G}$ =6 $\Omega$ $I_{D}$ =20A		40		no
$T_{d(off)}$	Turn-Off Delay Time <sup>3, 4</sup>			24	-	ns
$T_f$	Turn-Off Fall Time <sup>3, 4</sup>			75	1	
C <sub>iss</sub>	Input Capacitance			1427		
C <sub>oss</sub>	Output Capacitance	V <sub>DS</sub> =50V, V <sub>GS</sub> =0V, f=1MHz		258	-	рF
C <sub>rss</sub>	Reverse Transfer Capacitance			23		
$R_{g}$	Gate resistance	$V_{GS}$ =0V, $V_{DS}$ =0V, f=1MHz		0.7		Ω

### **Drain-Source Diode Characteristics**

$V_{SD}$	Source to Drain Diode Voltage	$V_{GS}$ =0V, $I_{S}$ =20A			1.5	V
t <sub>rr</sub>	Reverse Recovery Time	I <sub>s</sub> =20A, di/dt=100A/us	ł	29	1	ns
Q <sub>rr</sub>	Reverse Recovery Charge	11 <sub>S</sub> =20A, ui/ui=100A/uS		21		nC

### Note:

- 1. Repetitive Rating: Pulsed width limited by maximum junction temperature.
- 2. VDD=50V, VGS=10V, L=0.1mH, RG=25 $\Omega$ , Starting TJ=25 $^{\circ}$ C
- 3. The data tested by pulsed , pulse width  $\leq$ 300us , duty cycle  $\leq$ 2%.
- 4. Essentially independent of operating temperature.
- 5. Silicon limited.



Version 4.0 3 / 7

# 2. Characteristics Curves

# **Ratings and Characteristics Curves**

# (T<sub>A</sub> = 25°C unless otherwise specified)

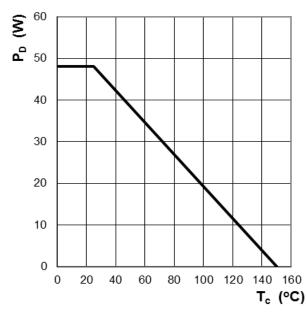


Figure 1: Power Dissipation

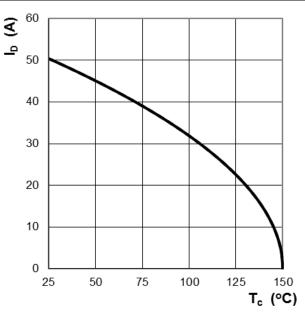


Figure 2: Continuous Drain Current vs. T<sub>C</sub>

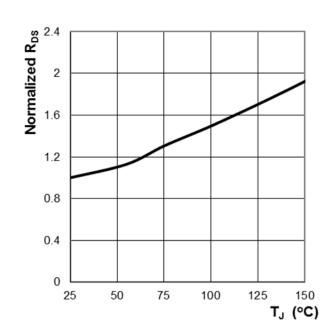


Figure 3: Normalized R<sub>DS(ON)</sub> vs. T<sub>J</sub>

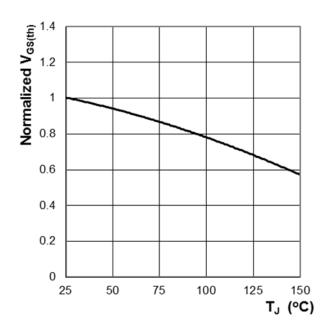


Figure 4: Normalized BV<sub>DSS</sub> vs. T<sub>J</sub>



Version 4.0 4 / 7

Characteristics PRM011N10S8

### **Ratings and Characteristics Curves**

( $T_A = 25^{\circ}$ C unless otherwise specified)

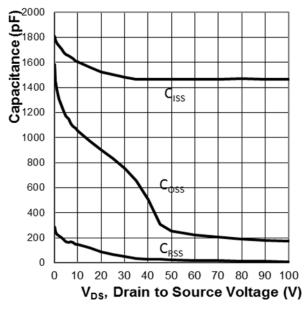


Figure 7: Typ. Capacitance Characteristics

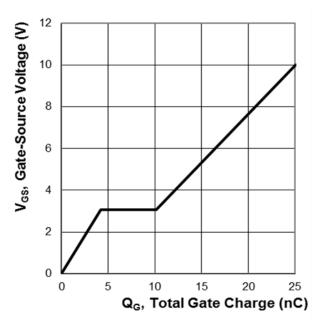


Figure 8: Typ. Gate Charge Characteristics

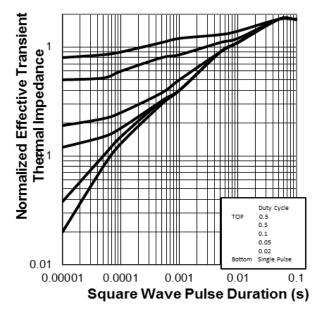


Figure 9: Normalized Thermal Transient Impedance, Junction-to-Case

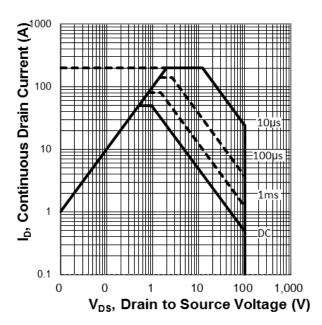


Figure 10: Maximum Safe Operation Area



Version 4.0 5 / 7

# 3. Marking information

**Top Marking Rule** 

PFC PRM
011N10S8
YYWW ABSH

PRM011N10S8 = Product Type Marking Code

YYWW = Date Code

YY = Last two digits of year

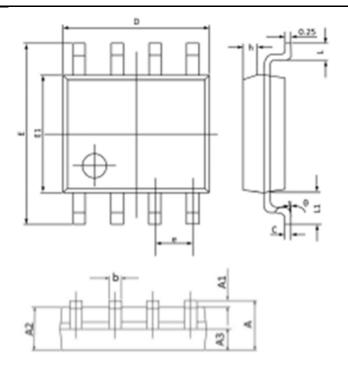
WW = Week code

ABS = Assembly code

H = Halogen Free (N/A = common molding compound)

# 4. Package information

# Package Outline Dimensions millimeters



Dim.	Min.	Max.			
A	1.35	1.75			
Al	0.10	0.25			
A2	1.30				
A3	0.60	0.70			
b	0.35	0.49			
c	0.18	0.26			
D	4.70	5.10			
E	5.80	6.20			
E1	3.70	4.10			
e	1.27	BSC			
h	0.25	0.50			
L	0.40	0.90			
Ll	1.05 BSC				
θ	0°	8°			
All Dimensions in mm					



Version 4.0 6 / 7

# 5. Ordering information

Part Number	Package	Delivery mode
PRM011N10S8	SOP-8	3000 pcs / 13" diameter reel

### Mechanical

Molder Plastic: UL Flammability Classification Rating 94V-0
 Device Weight: 0.003 ounces (0.085grams) – SOP-8

PFC Device Corp reserves the right to make changes without further notice to any products herein. PFC Device Corp makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does PFC Device Corp assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. "Typical" parameters which may be provided in PFC Device Corp data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typical" must be validated for each customer application by customer's technical experts. PFC Device Corp does not convey any license under its patent rights nor the rights of others. PFC Device Corp products are not designed, intended, or authorized for use as components in systems intended for surgical implant into the body, or other applications intended to support or sustain life, or for any other application in which the failure of the PFC Device Corp product could create a situation where personal injury or death may occur. Should Buyer purchase or use PFC Device Corp products for any such unintended or unauthorized application, Buyer shall indemnify and hold PFC Device Corp and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that PFC Device Corp was negligent regarding the design or manufacture of the part.



Version 4.0 7 / 7